

Features

- High Density Cell Design for Ultra Low R_{DS(on)}
- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

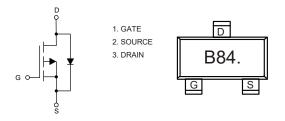
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 306°C/W Junction to Ambient (Note 2)

Parameter	Symbol	Rating	Unit		
Drain-Source Voltage		V _{DS}	-60	V	
Gate-Source Volltage		V _{GS}	±30	V	
Continuous Drain Current	T _A =25°C		-0.16	Α	
	T _A =100°C	· I _D	-0.1		
Pulsed Drain Current (Note 3)		I _{DM}	-0.64	Α	
Total Power Dissipation (Note 4)		P _D	400	mW	

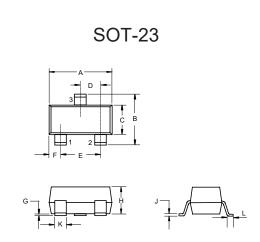
Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.
- 3. Repetitive rating; pulse width limited by max. junction temperature.
- 4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking Code

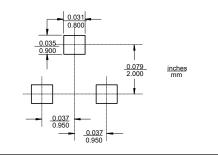


P-Channel MOSFET



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	NOIL
Α	0.110	0.120	2.80	3.04	
В	0.083	0.104	2.10	2.64	
С	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
Е	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
Н	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

Suggested Solder Pad Layout



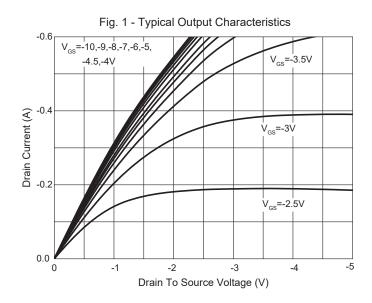


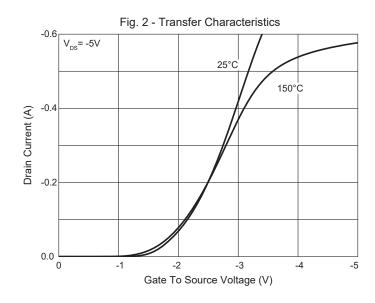
Electrical Characteristics @ 25°C (Unless Otherwise Specified)

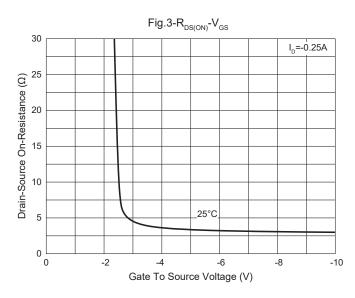
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics	-						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V _{GS} =0V, I _D =-250μA	-60			V	
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±30V			±500	nA	
		V _{DS} =0V, V _{GS} =±20V			±100		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =-60V, V_{GS} =0V			-1	μΑ	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-0.9	-1.3	-2.0	V	
D : 0 D : 1	-	V _{GS} =-10V, I _D =-0.15A			7.8	Ω	
Drain-Source On-Resistance	$R_{DS(on)}$	V _{GS} =-4.5V, I _D =-0.15A			9.5		
Gate Resistance	R _g	f=1 MHz, Open drain		24		Ω	
Diode Characteristics							
Continuous Body Diode Current	Is				-0.16	Α	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-0.17A			-1.2	V	
Reverse Recovery Time	t _{rr}	I _F =-0.15A,di/dt=100A/μs		23		ns	
Reverse Recovery Charge	Q _{rr}	- 1 _F 0.15Α,αΙ/αι-100Α/μS		13		nC	
Dynamic Characteristics					,		
Input Capacitance	C _{iss}			27		pF	
Output Capacitance	C _{oss}	V_{DS} =-30V, V_{GS} =0V,f=1MHz		6			
Reverse Transfer Capacitance	C _{rss}			3.3			
Total Gate Charge	Q _g			1.8			
Gate-Source Charge	Q_{gs}	V_{DS} =-30V, V_{GS} =-10V, I_{D} =-1A		0.6		nC	
Gate-Drain Charge	Q_{gd}			0.8			
Turn-On Delay Time	t _{d(on)}			8.6			
Turn-On Rise Time	t _r	V _{DS} =-30V, V _{GS} =-4.5V,		20		ns	
Turn-Off Delay Time	t _{d(off)}	$R_G = 2.5\Omega$, $I_D = -0.15A$		15			
Turn-Off Fall Time	t _f			77			

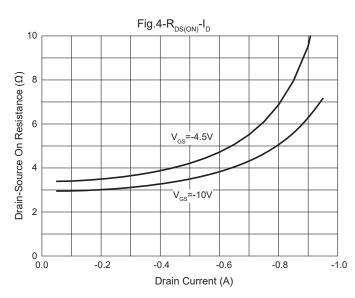


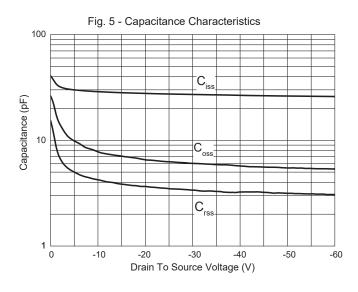
Curve Characteristics

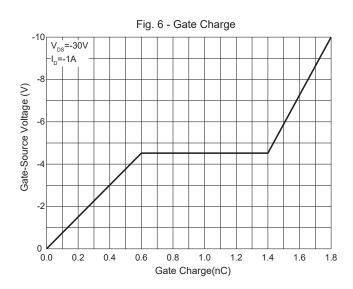














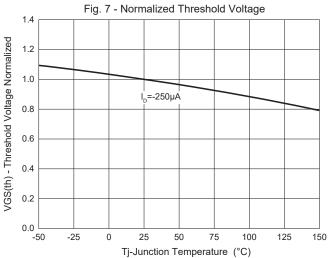
V_{GS}=0V

Source Current (A)

-0.1 -0.2

-0.4

Curve Characteristics

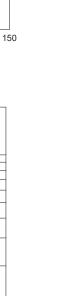


 ${\rm Fig.9-I_{\rm S}-V_{\rm SD}}$

150°C

-0.8

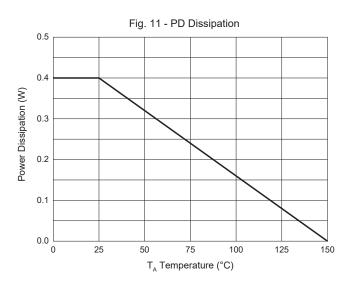
Source To Drain Voltage (V)

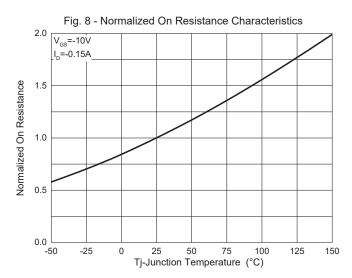


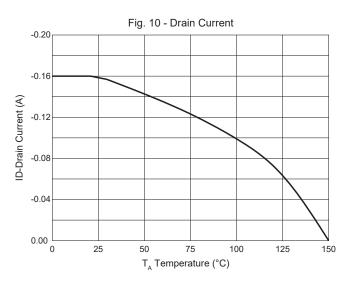
25°C

-1.0

-1.2









Curve Characteristics

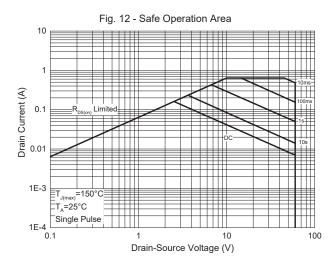
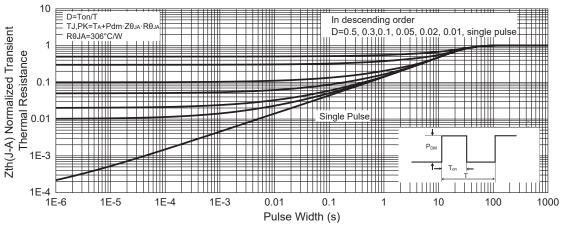


Fig. 13 - Normalized Transient Thermal Impedance





Ordering Information

Device	Packing		
Part Number-TP	Tape&Reel: 3Kpcs/Reel		
Part Number-13P	Tape&Reel: 10Kpcs/Reel		

For packaging details,go to our website at https://www.mccsemi.com/pdf/productpackaging/SOT-23%20Package.pdf

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